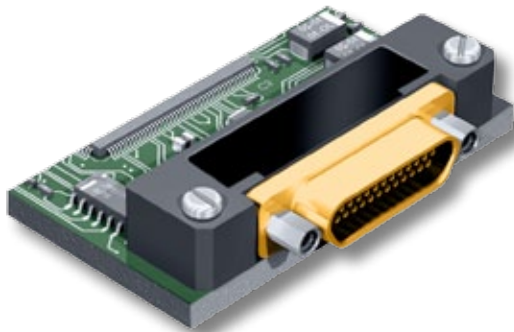




Micro-D Metal Shell Printed Circuit Board Connectors BR Style Right Angle Thru-Hole



High Performance—These connectors feature gold-plated TwistPin contacts for best performance. PC tails are .020 inch diameter. Specify nickel-plated shells or cadmium plated shells for best availability.

Solder-Dipped—Terminals are coated with SN63/Pb37 tin-lead solder for best solderability. Optional gold-plated terminals are available for RoHS compliance.

Front Panel or Rear Mountable—Can be installed through panels up to .125 inch thick. Specify rear panel mount jackposts.

HOW TO ORDER BR STYLE PCB MICRO-D CONNECTORS

	Shell Material and Finish	Insulator Material	Contact Layout	Contact Type	Termination Type	Jackpost Option	Threaded Insert Option	Terminal Length In Inches	Gold-Plated Terminal Mod Code
MWDM	Aluminum Shell	L – LCP 30% Glass-Filled Liquid Crystal Polymer	9	P	BR Board Right Angle	(Omit for None)	T	.080	These connectors are solder-dipped in 63/37 tin-lead solder.
	1 – Cadmium		15	Pin		P – Jackpost		.110	
	2 – Nickel		21				Threaded Insert In Board Mount Hole	.125	
	4 – Black Anodize		25	S		Jackposts for Rear Panel Mounting		.140	
	5 – Gold		31	Socket				.150	
	6 – Chem Film		37					.172	
		51		R1 – .032" Panel		(Omit for Thru-Hole)	.190	Length in Inches	To delete the solder dip and change to gold-plated terminals, add code 513
		100		R2 – .047" Panel			.250		
	Stainless Steel Shell			R3 – .062" Panel					
				R4 – .093" Panel					
3 – Passivated			R5 – .125" Panel		± .015 (0.38)				
Sample Part Number									
MWDM	1	L	– 15	P	BR	R3		– .110	

MICRO-D JACKPOST OPTIONS

No Designator	P	R1 Thru R5
HEX NUT EPOXY FILL		Panel
Thru-Hole For use with Glenair jackposts only. Order hardware separately. Install with threadlocking compound.	Standard Jackpost Factory installed, not intended for removal.	Jackpost for Rear Panel Mounting Shipped loosely installed. Install with permanent threadlocking compound.

Micro-D Metal Shell Printed Circuit Board Connectors BR Style Right Angle Thru-Hole



Micro-D
PCB

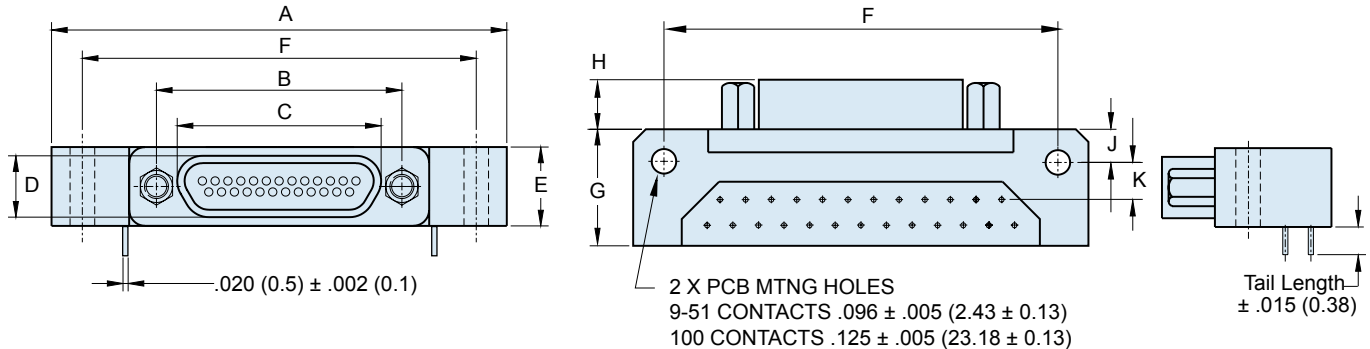
PERFORMANCE SPECIFICATIONS

Current Rating	3 AMP
DWV	600 VAC Sea level
Insulation Resistance	5000 Megohms Minimum
Contact Resistance	8 Milliohms Maximum
Low Level Contact Resist.	32 Milliohms Maximum
Magnetic Permeability	2 μ Maximum
Operating Temperature	-55° C. to +150° C.
Shock, Vibration	50 g., 20g.
Mating Force	(10 Ounces) X (# of Contacts)

MATERIALS AND FINISHES

Connector Shell	Aluminum Alloy 6061 or Stainless Steel, 300 Series, passivated. See Ordering Info for Plating Options
Insulator, Tray	Liquid Crystal Polymer (LCP)
Interfacial Seal	Fluorosilicone Rubber, Blue
Pin Contact	Copper Alloy, Gold over Nickel Plating
Socket Contact	Copper Alloy, Gold Over Nickel Plating
PCB Terminals	Gold Plated Copper Alloy, Solder Dipped
Hardware	300 Series Stainless Steel
Encapsulant	Epoxy Resin Hysol EE4215

C



BR STYLE MICRO-D PCB CONNECTORS

Layout	A Max.		B		C Max.		D Max.		E Max.		F		G Max.		H		J		K	
	In.	mm.	In.	mm.	In.	mm.	In.	mm.	In.	mm.	In.	mm.	In.	mm.	In.	mm.	In.	mm.	In.	mm.
9P	1.390	35.31	.565	14.35	.333	8.46	.184	4.67	.310	7.87	1.150	29.21	.465	11.81	.183	4.65	.125	3.18	.150	3.81
9S	1.390	35.31	.565	14.35	.400	10.16	.250	6.35	.310	7.87	1.150	29.21	.465	11.81	.195	4.95	.125	3.18	.150	3.81
15P	1.540	39.12	.715	18.16	.483	12.27	.184	4.67	.310	7.87	1.300	33.02	.465	11.81	.183	4.65	.125	3.18	.150	3.81
15S	1.540	39.12	.715	18.16	.551	14.00	.250	6.35	.310	7.87	1.300	33.02	.465	11.81	.195	4.95	.125	3.18	.150	3.81
21P	1.690	42.93	.865	21.97	.633	16.08	.184	4.67	.310	7.87	1.450	36.83	.465	11.81	.183	4.65	.125	3.18	.150	3.81
21S	1.690	42.93	.865	21.97	.701	17.81	.250	6.35	.310	7.87	1.450	36.83	.465	11.81	.195	4.95	.125	3.18	.150	3.81
25P	1.790	45.47	.965	24.51	.733	18.62	.184	4.67	.310	7.87	1.550	39.37	.465	11.81	.183	4.65	.125	3.18	.150	3.81
25S	1.790	45.47	.965	24.51	.801	20.35	.250	6.35	.310	7.87	1.550	39.37	.465	11.81	.195	4.95	.125	3.18	.150	3.81
31P	2.040	51.82	1.115	28.32	.883	22.43	.184	4.67	.310	7.87	1.800	45.72	.465	11.81	.183	4.65	.125	3.18	.150	3.81
31S	2.040	51.82	1.115	28.32	.951	24.16	.250	6.35	.310	7.87	1.800	45.72	.465	11.81	.195	4.95	.125	3.18	.150	3.81
37P	2.340	59.44	1.265	32.13	1.033	26.24	.184	4.67	.310	7.87	2.100	53.34	.465	11.81	.183	4.65	.125	3.18	.150	3.81
37S	2.340	59.44	1.265	32.13	1.101	27.96	.250	6.35	.310	7.87	2.100	53.34	.465	11.81	.195	4.95	.125	3.18	.150	3.81
51P	1.875	47.63	1.215	30.86	.983	24.97	.228	5.79	.351	8.92	1.600	40.64	.565	14.35	.183	4.65	.125	3.18	.150	3.81
51S	1.875	47.63	1.215	30.86	1.051	26.70	.296	7.52	.351	8.92	1.600	40.64	.565	14.35	.195	4.95	.125	3.18	.150	3.81
100P	2.780	70.60	1.800	45.72	1.383	35.13	.270	6.86	.394	10.01	2.500	63.50	.765	19.43	.183	4.65	.225	5.72	.150	3.81
100S	2.780	70.60	1.800	45.72	1.451	36.86	.333	8.46	.394	10.01	2.500	63.50	.765	19.43	.195	4.95	.225	5.72	.150	3.81

MICRO-D BR BOARD MOUNT CONNECTOR PCB LAYOUTS – PIN CONNECTORS

Patterns shown are for connector mounting side of PC board. 9 Thru 51 Contacts .096 (2.44) Diameter Mounting Holes, 100 Pin .125 (3.18) Diameter



9 PIN MWDM-9PBR



51 PIN MWDM-51PBR



15 PIN MWDM-15PBR



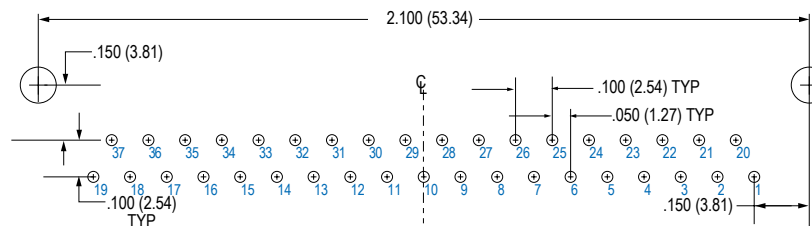
31 PIN MWDM-31PBR



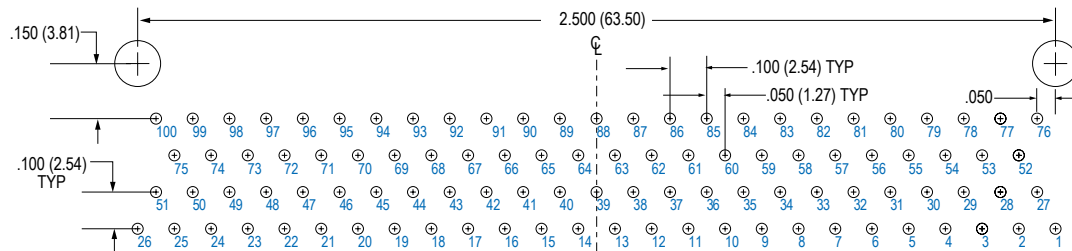
21 PIN MWDM-21PBR



25 PIN MWDM-25PBR



37 PIN MWDM-37PBR



100 PIN MWDM-100PBR

Micro-D Metal Shell Printed Circuit Board Connectors BR Style Right Angle Thru-Hole



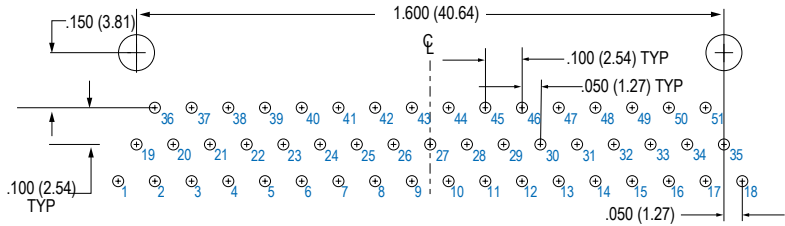
Micro-D
PCB

MICRO-D BR BOARD MOUNT CONNECTOR PCB LAYOUTS – SOCKET CONNECTORS

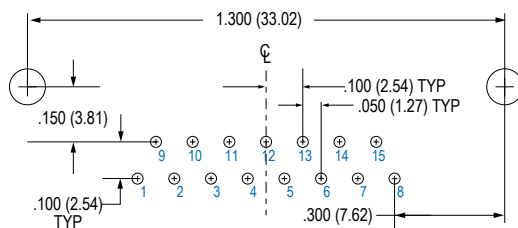
Patterns shown are for connector mounting side of PC board. 9 Thru 51 Contacts .096 (2.44) Diameter Mounting Holes, 100 Pin .125 (3.18) Diameter



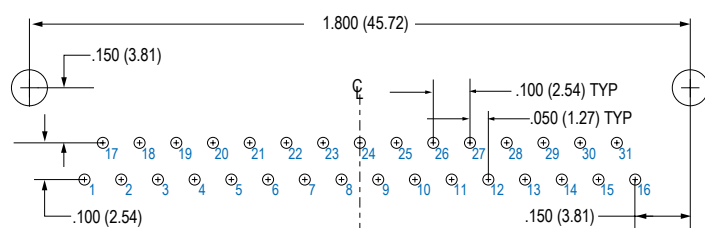
9 SOCKET MWDM-9SBR



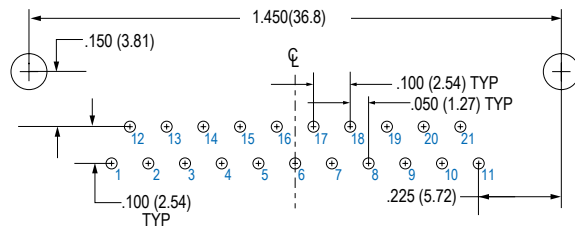
51 SOCKET MWDM-51SBR



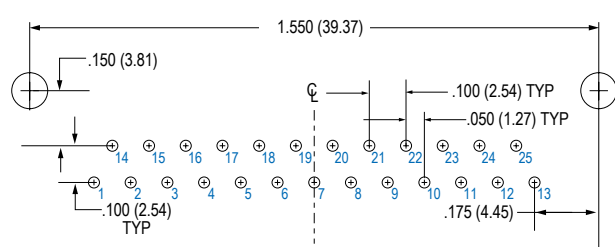
15 SOCKET MWDM-15SBR



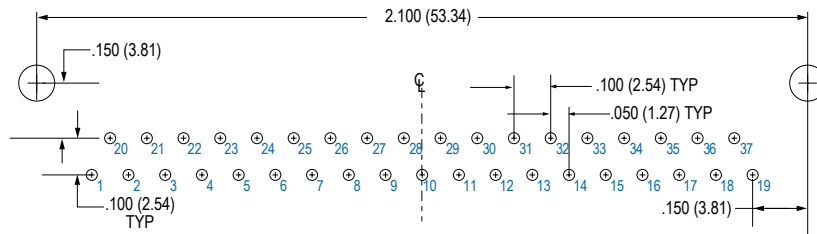
31 SOCKET MWDM-31SBR



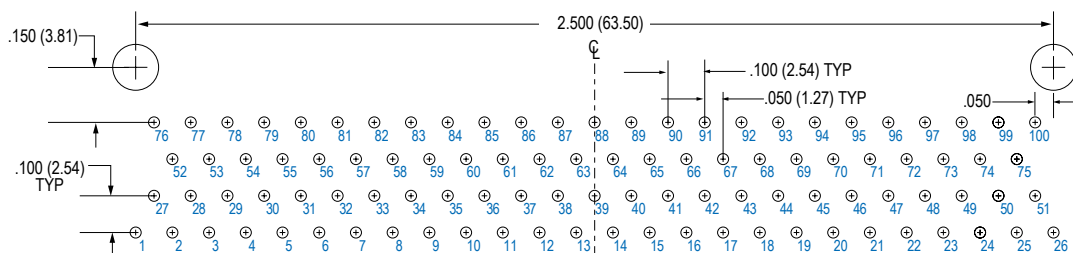
21 SOCKET MWDM-21SBR



25 SOCKET MWDM-25SBR



37 SOCKET MWDM-37SBR



100 SOCKET MWDM-100SBR

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9